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RESPONSE UNDER 37 CFR 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP: 2827

32692
Customer Number

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Patent
Case No.: 53434US009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named Inventor: HOGERTON, PETER B.

Application No.: 09/690,600

Group Art Unit: 2827

Filed:

October 17, 2000

Examiner: Luan C. Thai

Title:

SOLVENT ASSISTED BURNISHING OF PRE-UNDERILLED
SOLDER-BUMPED WAFERS FOR FLIPCHIP BONDING

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AMENDMENT AND RESPONSE UNDER 37 CFR § 1.116

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF TRANSMISSION	
To Fax No.:	703-872-9306
I hereby certify that this correspondence is being facsimile transmitted to the U.S. Patent and Trademark Office on:	
18 May 2004	<i>Dean M. Harts</i>
Date	Signed by: Susan P. Gurnatz or Dean M. Harts

Dear Sir:

This is in response to the outstanding Office Action, mailed March 25, 2004, in the above-identified application.

This response is filed within two months of said mailing date.

This Amendment is believed to be timely submitted. It is believed that no fee is due; however, in the event a fee is required, please charge the fee to Deposit Account No. 13-3723.